广东惠伦晶体科技股份有限公司
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PRODUCT SPECIFICATION SHEET

CUSTOMER	:	
PRODUCT TYPE	:	SMD X'TAL 3.2*2.5(4PAD)
NOMINAL FREQ.	:	40.000000 MHz
FL P/N	:	3S40000299
REVISION	:	S1
CUSTOMER P/N	:	

CUSTOMER'S APPROVAL&DATE

FL CORPORATION

APPROVED	CHECKED	DESIGNED
Liu Feng	Liao Xiaohua	Li Xiang

MSL1

RoHS Compliant

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ATTACHMENT（optional）

- ELECTRICAL CHARACTERISTICS TEST A ☐ YES ☑ NO
- TEMPERATURE CHARACTERISTICS TEST B ☐ YES ☑ NO

Attention

- If you intend to use products on the controlling equipment that relate to medical, aeronautical, aerospace, military science, space and etc, please make sure to let us know your intentions in advance.
- Ultrasonic related process may cause damage to crystal blank by resonance itself. If ultrasonic related process is used, we strongly recommend to assess the damage risk under related ultrasonic conditions before use in production.

SPECIFICATION REVISION RECORD SHEET

Rev.	Revise page	Revise Contents	Date	Ref. No.	Reviser
S0	N/A	Initial released	25-May-22	N/A	Chen XuanRu
S1	P.1、P.4	P.1 Add attention information P.4 Update suggested reflow profile	29-Mar-23	N/A	Li Xiang

PRODUCT DESCRIPION

Standard atmospheric conditions

Unless otherwise specified. The standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature 25±2℃
Relative humidity 40%~70%

If there is no doubt the results, measurement shall be made within the following limits:

Ambient temperature 25±2℃
Relative humidity : 40%~70%

Measure equipment

Electrical characteristics measured by S&A250B or equivalent.

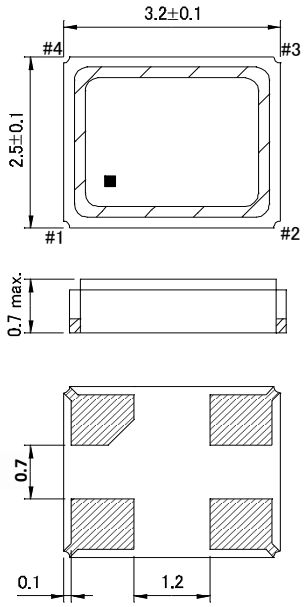
Crystal cutting type

The crystal is using AT CUT (thickness shear mode)

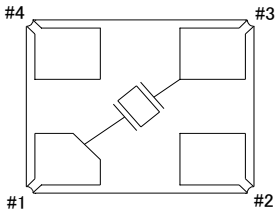
ELECTRICAL SPECIFICATIONS

No.	Items	Electrical Spec.					Remarks
		Symbol	Min	Typ	Max	Units	
1	Nominal Frequency	FL	40.000000			MHz	-
2	Oscillation Mode	-	Fundamental			-	-
3	Load Capacitance	CL	12.0			pF	-
4	Frequency Tolerance	-	±10			ppm	at 25±2℃
5	Frequency Stability	-	±10			ppm	at -30～+85℃ (reference 25℃)
6	Shunt Capacitance	C0	-	-	2	pF	-
7	Aging (/1 year)	-	±2			ppm/year	at 25±2℃
8	Operating Temperature	-	-30	-	85	℃	-
9	Storage Temperature	-	-40	-	85	℃	-
10	Equivalent series resistance	ESR	-	-	15	ohms	-
11	DLD2	-	-	-	6	ohms	-
12	Insulation Resistance	IR	500	-	-	M-ohms	at DC 100V
13	ESD	-	HBM＞4000V			-	ANSI/ESDA/JEDEC JS-001
14	MSL	-	Level 1			-	J-STD-020
15	Drive Level	DL	-	10	100	uW	-

DIMENSIONS unit:mm

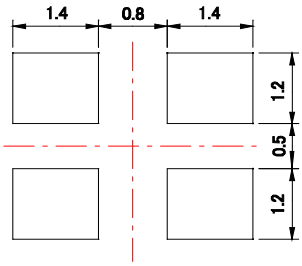


CONNECTION DIAGRAM (TOP VIEW)

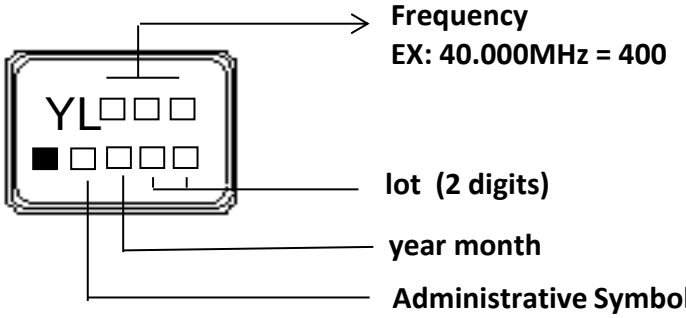


Pin	Function
#1	Xtal terminal (Input)
#2	GND terminal
#3	Xtal terminal (Output)
#4	GND terminal

LAND PATTERN unit:mm



MARKING

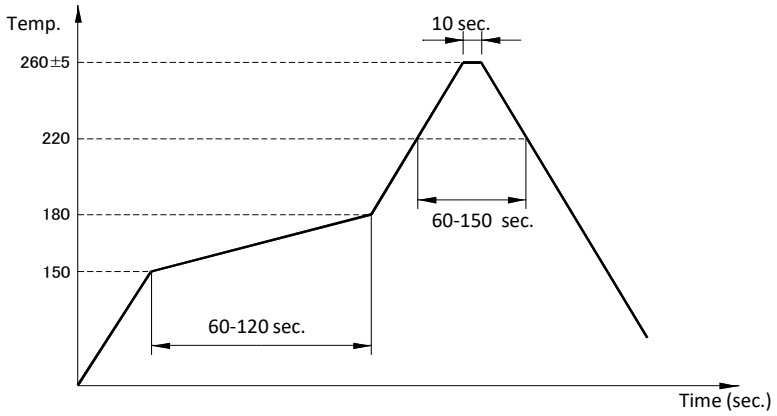


year \ month		JAN	FEB	MAR	APR	MAY	JUN	JUL	AUG	SEP	OCT	NOV	DEC
2021	2025	A	B	C	D	E	F	G	H	J	K	L	M
2022	2026	N	P	Q	R	S	T	U	V	W	X	Y	Z
2023	2027	a	b	c	d	e	f	g	h	j	k	l	m
2024	2028	n	p	q	r	s	t	u	v	w	x	y	z

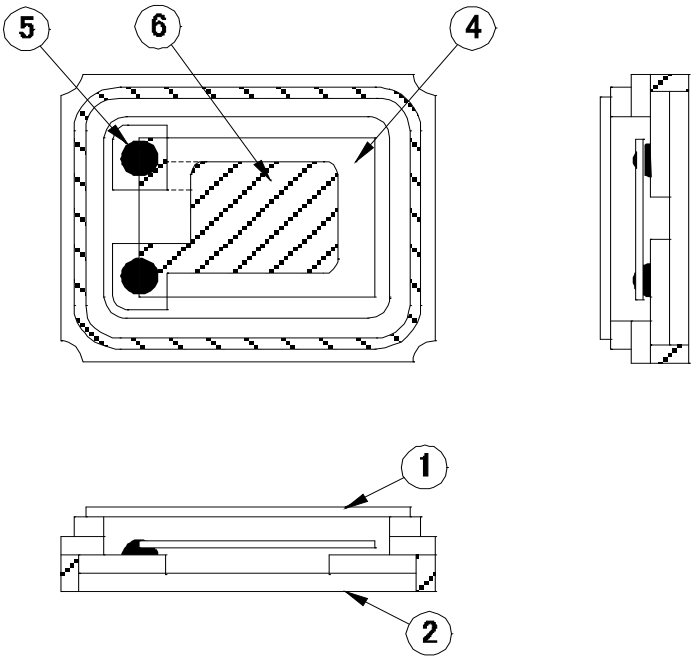
SUGGESTED REFLOW PROFILE

Total time : 360 sec. Max.

Solder melting point : 225 °C



STRUCTURE ILLUSTRATION



NO	COMPONENTS	MATERIALS	QTY	FINISH/SPECIFICATIONS
1	Cap(Lid)	Kovar(Fe+Co+Ni)	1	Ni plating
2	Base(Package)	Almina Ceramics (Al_2O_3)	1	
3	Pad(Package)	Ni + Au	4	Ni+Au plating
4	Crystal blank	SiO_2	1	-
5	Conductive adhesive	Ag	2	Silicone resin
6	Electrode	Noble metal	2	-

RELIABILITY SPECIFICATIONS

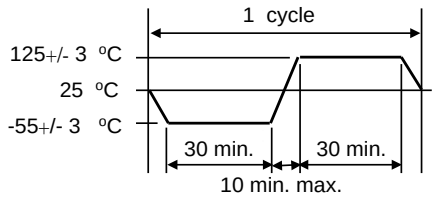
1.MECHANICAL ENDURANCE

No.	Test Item	Test Methods	
1	Drop Test	150 cm height, fall freely onto stainless plate 3 times.	JIS C6701
2	Shock Test	150g/150cm Height,3times in the direction of ±x, ±y, ±z on concrete floor	IEC-68-02-27
3	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutua pendicular axes each 3 times. 1.0m sec. duration time	MIL-STD-202F
4	Vibration	Frequency range 10 ~ 55 Hz Amplitude 1.52 mm Pendicular axes each test tim 2 hours（x,y,z Axis） Total test time 6 hours	MIL-STD-883E
5	Gross Leak	Standard Sample For Automatic Gross Leak Detector Test Pressure 2kg/cm2	MIL-STD-883E
6	Fine Leak	Helium Bombing 4.5kgf/cm2 for 2 hr	MIL-STD-883E
7	Solderability	Temperature 260 °C ±5 °C Immersing depth 0.5 mm minimum Immersion time 5 ± 1 seconds Flux Rosin resin methyl alcohol solvent (1 : 4)	GB/T 2424.17-2008 / IEC 60068-2-44:1995; GB/T 2423.28-2005 / IEC 60068-2-20:1979
8	Resistance To Soldering Heat	Pre-heat temperature 125 °C Pre-heat time 60 ~ 120 sec. Test temperature 260 +/- 5 °C Test time 5 +/- 1 sec.	MIL-STD-202F

*Storage conditions： 18 months

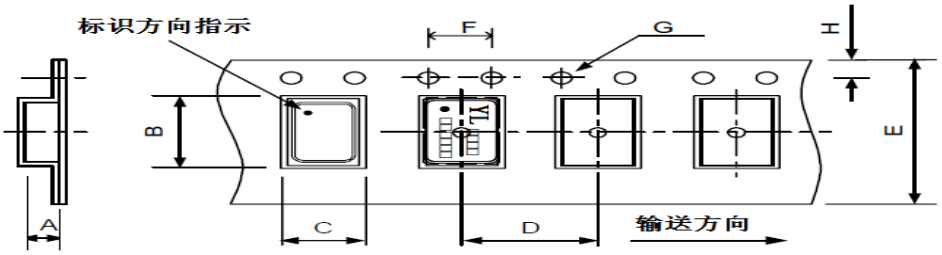
*Constant humidity： 40~70%

2.ENVIRONMENTAL ENDURANCE

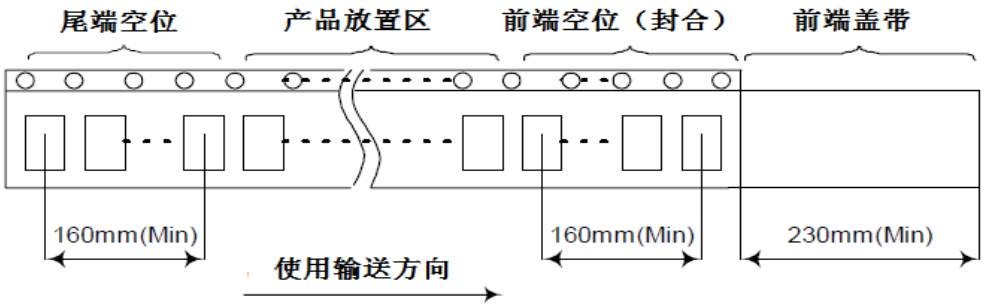
No.	Test Item	Test Methods	
9	High Temp. Storage	+ 125 °C +/- 3 °C for 500 +/- 12 hours	MIL-STD-883E
10	Low Temp. Storage	- 40 °C +/- 3 °C for 500 +/- 12 hours	
11	Thermal Shock	Total 100 cycles of the following temperature cycle 	MIL-STD-883E
12	High Temp&Homidity	85℃±3℃, RH 85%,500Hrs	JIS C5023

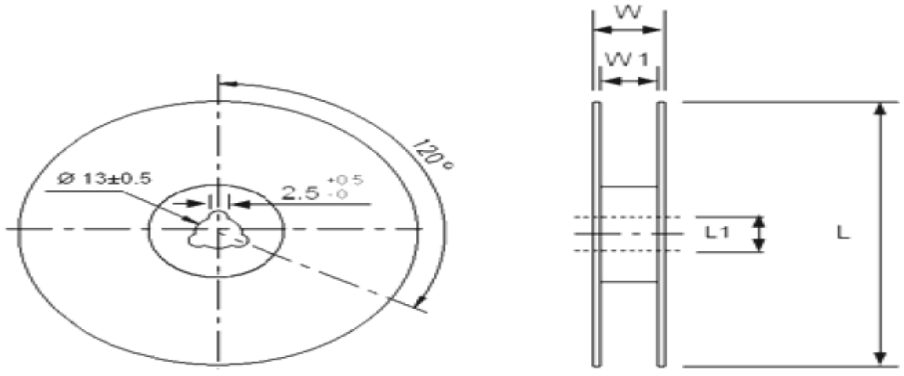
PACKING :

8mm-4mm，3000pcs / reel，φ178；



Dimension	A	B	C	D	E	F	G	H	Unit：mm
	1.40 ±0.1	3.40 ±0.1	2.70 ±0.1	4.00	8.00	4.00	1.50	1.75	





Dimension	L	L1	W	W1	Unit：mm
	178	13	11.5	8	3000pcs / reel

SMD PRODUCT PACKING STANDARD

Out-going packing instruction

Reel Packing	Inner Packing	Carton
name：reel standard：diameter 18cm material：plastics	name：Bubble Wrap standard：430×330+20mm material：HDPE(15 reels enter)	name：carton standard：400×400×280mm material：AB corrugated paper(4 bags enter)
		
		

The label instruction

Label Drawing	Mark	Name of Article	Spec.	Size	Printing
	L1	条码标签 Bar Code Label (Chintz Paper)	1.Part No. 2.Lot No. 3.Q'ty 4.Freq	70x50mm	White
	L2	条码标签 Bar Code Label (Chintz Paper)	1.Part No. 2.Date Code 3.Q'ty 4.Freq	70x50mm	White

Remark

Specifications on the label is for the use of templates with different product specifications may vary.
If customer specified requirements for labels packaging. please provide the operation procedure.

Range	Products	Packing Material
Banned Substances	**Maximum concentration ppm(mg/kg)**	**Maximum concentration ppm(mg/kg)**
1.镉及镉化合物 Cadmium and cadmium compounds	100	100
2.铅及铅化合物 Lead and lead compounds	1000	100
3.汞及汞化合物 Mercury and mercury compounds	1000	100
4.六价铬化合物 Hexavalent-Chromium VI (Cr+6)	1000	100
5.聚溴联苯 PBB Polybrominated biphenyls	1000	N/A
6.聚溴二苯醚 PBDE Polybrominated diphenyl ethers	1000	N/A
7.邻苯二甲酸二(2-乙基已基)酯 DEHP Di (2-ethylhexyl) phthalate	1000	N/A
8.邻苯二甲酸丁苄酯 BBP Butyl Benzyl Phthalate	1000	N/A
9.邻苯二甲酸二丁酯 DBP Dibutyl Phthalate	1000	N/A
10 邻苯二甲酸二异丁酯 DIBP Diisobutyl Phthalate	1000	N/A
11. 氟（F）、氯（Cl）、溴（Br）、碘（I） Fluorine、Chlorine、 Bromine、	900、900、900、900 注：Br+Cl＜1000	N/A
12.包装材料中重金属(汞、镉、六价铬、铅、PBB、PBDE)之总量 Heavy metals (mercury, cadmium, lead, Cr+6,PBB and PBDE) in packing materials	N/A	100 铅(Pb) + 镉(Cd) + 汞(Hg) + 六价铬(Cr+6) <100ppm
13.高度关注物质 SVHC-Substances of Very High Concern	1000	N/A


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FAITH LONG CRYSTAL